

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
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APPLICATION STANDARD			
RATING	OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C	STORAGE TEMPERATURE RANGE
	VOLTAGE	AC 50 V	OPERATING HUMIDITY RANGE
	CURRENT	0.3 A	RELATIVE HUMIDITY : 95 % MAX (NO DEW CONDENSATION IS PERMITTED)

SPECIFICATIONS						
ITEM	TEST METHOD	REQUIREMENT	QT	AT		
CONSTRUCTION						
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING	X X		
MARKING	CONFIRMED VISUALLY.			X X		
ELECTRICAL CHARACTERISTICS						
CONTACT RESISTANCE	100 mA (DC OR 1000 Hz).	70 mΩ MAX.	X	X		
INSULATION RESISTANCE	100 V DC.	100 MΩ MIN.	X	—		
VOLTAGE PROOF	150 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN	X	X		
MECHANICAL CHARACTERISTICS						
INSERTION AND WITHDRAWAL FORCES	MEASURED BY APPLICABLE CONNECTOR.	INSERTION FORCE: 60 N MAX. WITHDRAWAL FORCE: 2.5 N MIN.	X	—		
MECHANICAL OPERATION	50 TIMES INSERTION AND EXTRACTIONS.	1) CONTACT RESISTANCE: 80 mΩ MAX 2) NO DAMAGE, CRACK AND LOOSENESS OF PART.	X	—		
VIBRATION	FREQUENCY: 10 TO 55 Hz. SINGLE AMPLITUDE: 0.75 mm. — m/s ² AT 10 CYCLES FOR 3 DIRECTIONS.	1) NO ELECTRICAL DISCONTINUITY OF 1 μs MIN. 2) NO DAMAGE, CRACK AND LOOSENESS OF PART.	X	—		
SHOCK	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	—		
ENVIRONMENTAL CHARACTERISTICS						
DAMP HEAT (STEADY STATE)	EXPOSED AT 40±2 °C, 90~95 %, 96 h.	1) CONTACT RESISTANCE: 80 mΩ MAX. 2) INSULATION RESISTANCE: 100 MΩ MIN.	X	—		
RAPID CHAGE OF TEMPERTURE	TEMPERTURE -55→15~35→ 85→15~35°C TIME 30→ 2~ 3→ 30→ 2~ 3 min. UNDER 5 CYCLES.	3) NO DAMAGE, CRACK AND LOOSENESS OF PART.	X	—		
DRY HEAT	EXPOSED AT 85 °C, 96 h.	1) CONTACT RESISTANCE: 80 mΩ MAX.	X	—		
COLD	EXPOSED AT -55 °C, 96 h.	2) NO DAMAGE, CRACK AND LOOSENESS OF PART.	X	—		
CORROSION SALT MIST	EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h.	NO HEAVY CORROSION.	X	—		
SULPHUR DIOXIDE	EXPOSED IN 10 PPM FOR 96 h. (TEST STANDARD: JIS C 0090)	1) CONTACT RESISTANCE: 80 mΩ MAX 2) NO HEAVY CORROSION.	X	—		
RESISTANCE TO SOLDERING HEAT	REFLOW RECOMMENDED TEMPERATURE PROFILE <p>25°C (160 S) 150°C 160°C (60~90 S) 240°C 5 S MAX 200°C (30 S) (20~30 S)</p> <p>TO BE TESTED UNDER THE ABOVE CONDITIONS.</p>	NO MELTING OF RESIN WHICH AFFECTS THE PERFORMANCE OF COMPONENT.	X	—		
SOLDRABILITY	SOLDERED AT SOLDER TEMPERATURE, 235 °C FOR IMMERSION DURATION, 2 s.	NO PINHOLE OR DEWETTING ON SOLDERED SURFACE.	X	—		
REMARKS		DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
		J. Matsukawa	J. Matsukawa	M. Sakai	T. Yoshimura	
UNLESS OTERWISE SPECIFIED ,REFER TO JIS C 5402.		00.01.15	00.01.15	00.01.17	00.01.17	
NOTE QT: QUALIFICATION TEST AT: ASSURANCE TEST X: APPLICABLE TEST						
HRS HIROSE ELECTRIC CO., LTD.		SPECIFICATION SHEET		PART NO.		
CODE NO.(OLD)		DRAWING NO.		CODE NO		
CL		ELC4 - 152645 -		CL 573 - 0753 - 0 -		

DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

TO
PCK